

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Chung et al. Serial No.: 10/043,027 Confirmation No.: 6119 Group Art Unit: 2813

Filed: January 9, 2002

Examiner: William C. Vesperman

METHODS OF FORMING AN INTEGRATED CIRCUIT CAPACITOR IN WHICH

A METAL PREPROCESSED LAYER IS FORMED ON AN ELECTRODE

THEREOF

Date: September 4, 2003

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

AMENDMENT

Sir:

Applicants provide the present Amendment to address the issues raised in the Official Action mailed June 5, 2003. Applicant provides the present Amendment pursuant to the rules stated in revised 37 C.F.R. 1.121 that became effective on July 30, 2003.